

JC979UUB-PTO
09/27/025

ISSUE CLASSIFICATION	
Class	Subclass
2	

O.I.P.E.	PATENT DATE
<i>TR</i> SCANNED <i>TR3</i> <i>aa/m</i>	

APPLICATION NO. 09/974025	CONT/PRIOR F	CLASS 257	SUBCLASS 737	ART UNIT 2811	EXAMINER T. P. D. 14
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Jong-Hyon Ahn
Chang-Hun Lee

Flip chip type semiconductor device and method of fabricating the same

PTO-2040
12/89

ISSUING CLASSIFICATION																											
ORIGINAL				CROSS REFERENCE(S)																							
CLASS				SUBCLASS				CLASS				SUBCLASS (ONE SUBCLASS PER BLOCK)															
INTERNATIONAL CLASSIFICATION																											

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	Sheets Dwg.	Figs. Dwg.	Print Fig.	Total Claims	Print Claim for O.G.
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<input type="checkbox"/> The term of this patent shall not extend beyond the expiration date of U.S Patent. No. _____ _____ _____	_____ (Primary Examiner) _____ (Date)			ISSUE FEE	
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